



1 2 3 4 5 6

A

A

PCB Number: 6593181  
PCB Rev: A



B

B

ZZ2

Assembly Note  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3

Assembly Note  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4

Assembly Note  
These assemblies must comply with workmanship standards IPC-A-610 Class 2., unless otherwise specified.

D

D

TIDA-00522		LMH5401 RC IN EVM Low Gain Amplifier Reference Design	
Number: 6593181   Rev: A		Designed for: Public Release	Mod. Date: 8/18/2015
SVN Rev. Version control disabled		Project Title: LMH5401_RC_IN	
Drawn By: Bob Holtz		Sheet Title:	Sheet: 2 of 2
Engineer: Loren Siebert		Assembly Variant: 001	File: LMH5401_RC_In-A_Hardware_SchDoc   Size: B
		Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	<a href="http://www.ti.com">http://www.ti.com</a>
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